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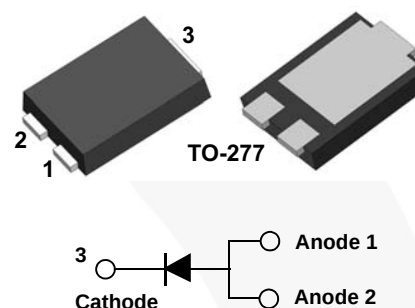
September 2015

FSV2050V

20 A, 50 V Ultra Low VF Schottky Rectifier

Features

- Ultra Low Forward Voltage Drop
- Low Thermal Resistance
- Very Low Profile: Typical Height of 1.1 mm
- RoHS Compliant
- Green Molding Compound as per IEC61249 Standard
- Lead Free in Compliance with EU RoHS 2011/65/EU Directive
- Qualified with Reflow (J-STD-020) and Solder Temperature 260°C Classification



Ordering Information

Part Number	Top Mark	Package	Packing Method
FSV2050V	FSV2050V	TO-277 3L	Tape and Reel

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{RRM}	Peak Repetitive Reverse Voltage	50	V
V_{RWM}	Working Peak Reverse Voltage	50	V
V_{RMS}	RMS Reverse Voltage	35	V
V_R	DC Blocking Voltage	50	V
$I_{F(AV)}$	Average Rectified Peak Forward Surge Current	20	A
I_{FSM}	Non-Repetitive Peak Forward Surge Current	320	A
T_J	Operating Junction Temperature Range	-55 to +150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to +150	$^\circ\text{C}$

FSV2050V — 20 A, 50 V Ultra Low VF Schottky Rectifier

Thermal Characteristics⁽¹⁾

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Minimum Land Pattern	Maximum Land Pattern	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance	100	40	$^\circ\text{C/W}$
Ψ_{JL}	Junction-to-Lead Thermal Characteristics, Thermocouple Soldered to Anode	15	12	$^\circ\text{C/W}$
	Junction-to-Lead Thermal Characteristics, Thermocouple Soldered to Cathode	6	5	

Note:

- The thermal resistances ($R_{\theta JA}$ & Ψ_{JL}) are characterized with device mounted on the following FR4 printed circuit boards, as shown in Figure 1 and Figure 2. PCB size: 76.2 x 114.3 mm. Minimum land pattern size: 4.9 x 4.8 mm (big pattern, x1), 1.4 x 1.52 mm (small pattern, x2). Maximum land pattern size: 30 x 30 mm (pattern, x2). Force line trace size = 55 mils, sense line trace size = 4 mils.



Figure 1. Minimum Land Pattern of 2 oz Copper



Figure 2. Maximum Land Pattern of 2 oz Copper

Electrical Characteristics

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_R	Breakdown Voltage	$I_R = 500 \mu\text{A}$	50	55.3		V
V_F	Forward Voltage Drop	$I_F = 20 \text{ A}$		485	550	mV
I_R	Reverse Current	$V_R = 50 \text{ V}$		60.3	320	μA

Typical Performance Characteristics

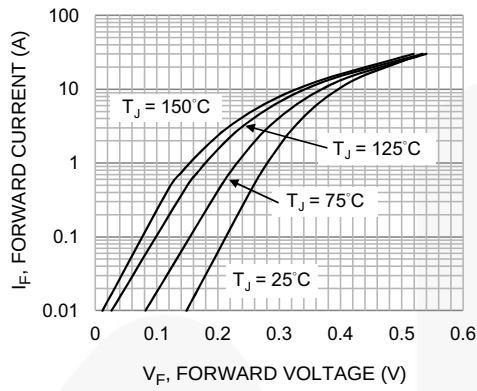


Figure 3. Typical Forward Characteristics

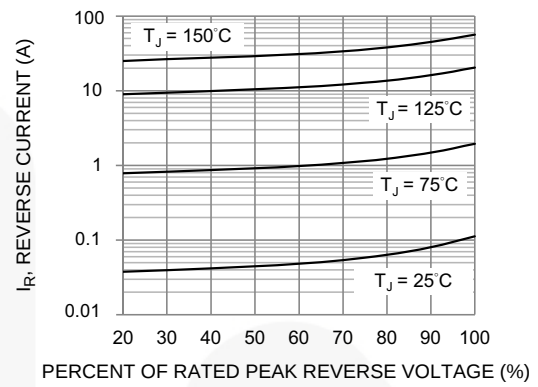


Figure 4. Typical Reverse Characteristic

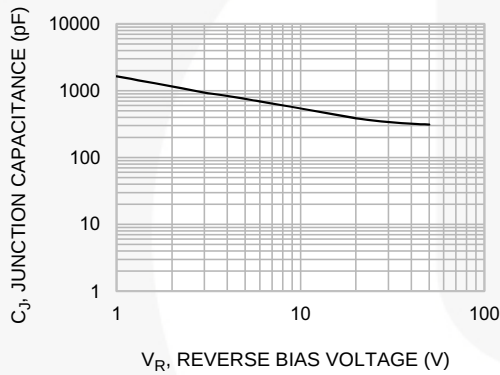


Figure 5. Typical Junction Capacitance

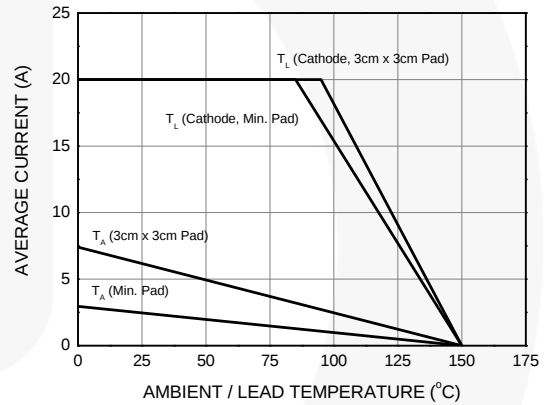
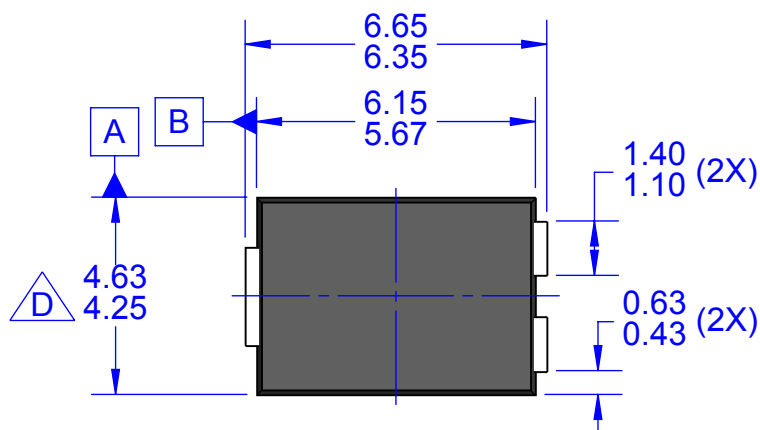


Figure 6. Forward Current Derating Curve



TOP VIEW

SEATING
PLANE

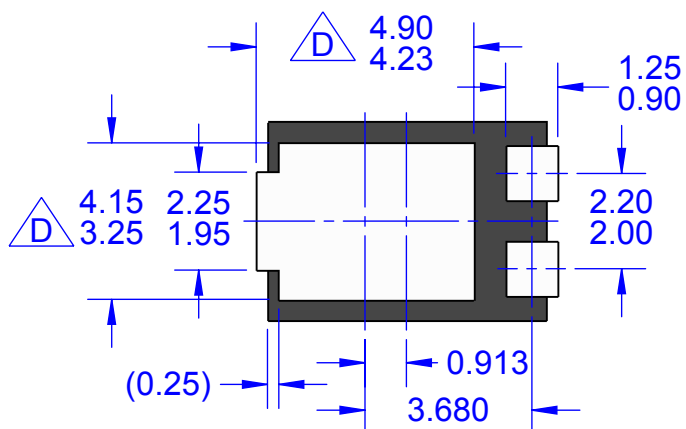
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FRONT VIEW



LAND PATTERN RECOMMENDATION



BOTTOM VIEW

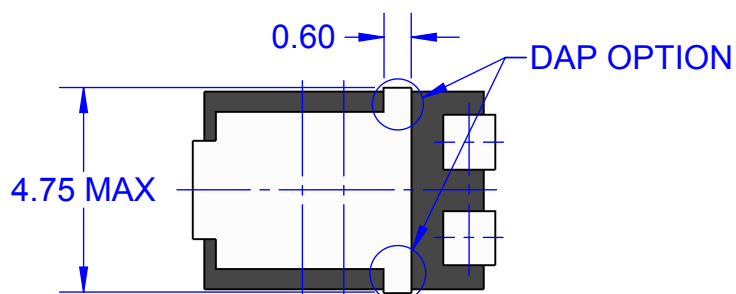
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BOTTOM VIEW - DAP OPTION



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